

Device Modeling Report

COMPONENTS: Power MOSFET (Professional)
PART NUMBER: TPCM8001-H
MANUFACTURER: TOSHIBA
Body Diode (Special) / ESD Protection Diode

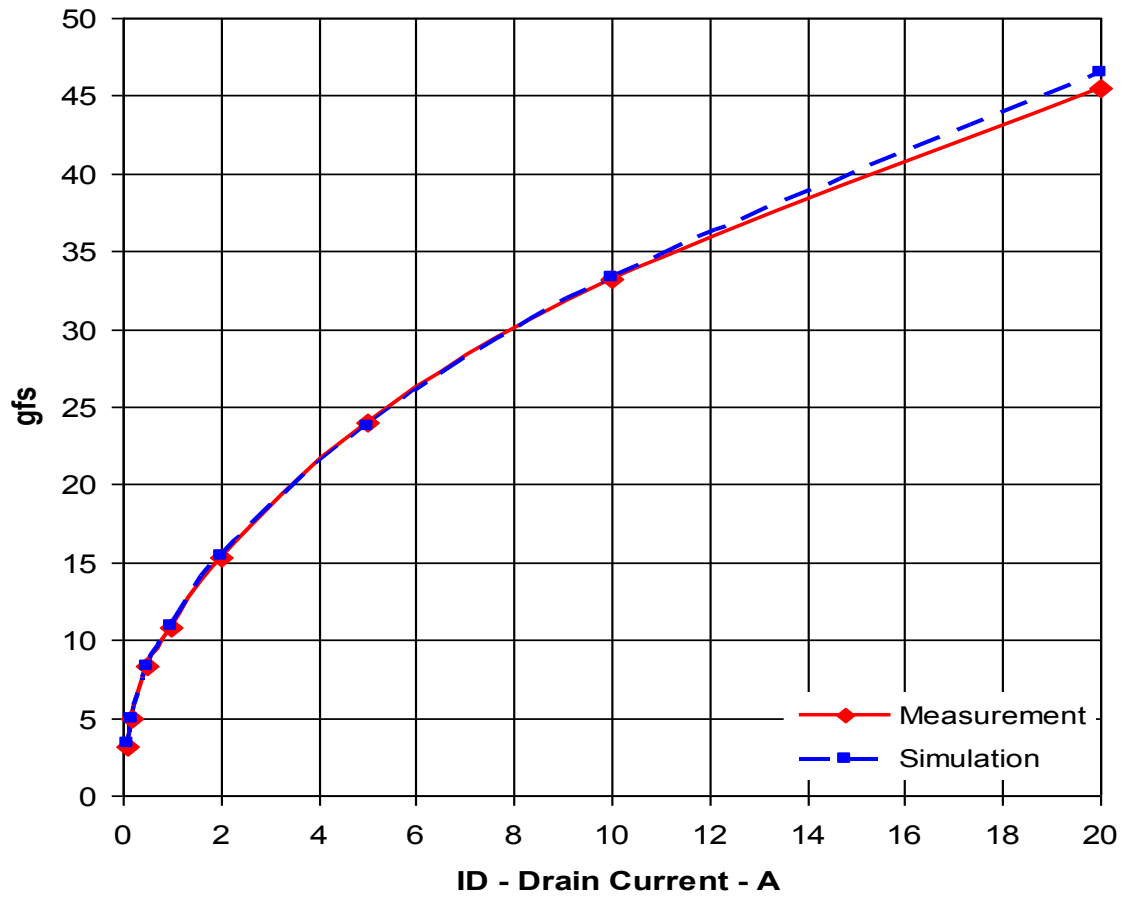


MOSFET MODEL

PSpice model parameter	Model description
LEVEL	
L	Channel Length
W	Channel Width
KP	Transconductance
RS	Source Ohmic Resistance
RD	Ohmic Drain Resistance
VTO	Zero-bias Threshold Voltage
RDS	Drain-Source Shunt Resistance
TOX	Gate Oxide Thickness
CGSO	Zero-bias Gate-Source Capacitance
CGDO	Zero-bias Gate-Drain Capacitance
CBD	Zero-bias Bulk-Drain Junction Capacitance
MJ	Bulk Junction Grading Coefficient
PB	Bulk Junction Potential
FC	Bulk Junction Forward-bias Capacitance Coefficient
RG	Gate Ohmic Resistance
IS	Bulk Junction Saturation Current
N	Bulk Junction Emission Coefficient
RB	Bulk Series Resistance
PHI	Surface Inversion Potential
GAMMA	Body-effect Parameter
DELTA	Width effect on Threshold Voltage
ETA	Static Feedback on Threshold Voltage
THETA	Mobility Modulation
KAPPA	Saturation Field Factor
VMAX	Maximum Drift Velocity of Carriers
XJ	Metallurgical Junction Depth
UO	Surface Mobility

Transconductance Characteristic

Circuit Simulation Result

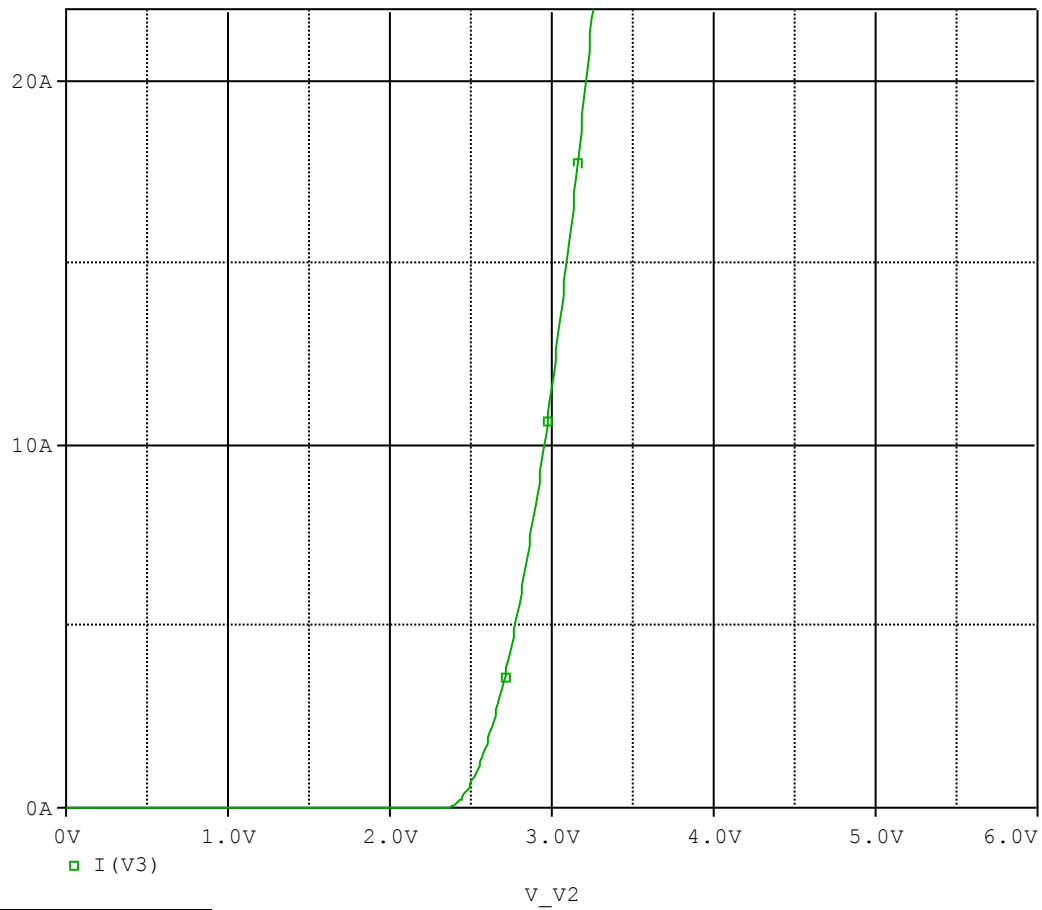


Comparison table

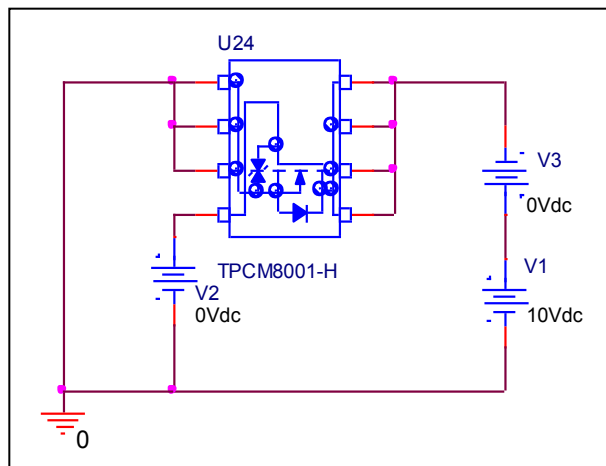
Id(A)	gfs		Error(%)
	Measurement	Simulation	
0.1	3.200	3.333	4.156
0.2	5.000	5.000	0.000
0.5	8.300	8.333	0.398
1	10.850	10.950	0.922
2	15.300	15.385	0.556
5	24.000	23.810	-0.792
10	33.200	33.333	0.401
20	45.500	46.512	2.224

Vgs-Id Characteristic

Circuit Simulation result

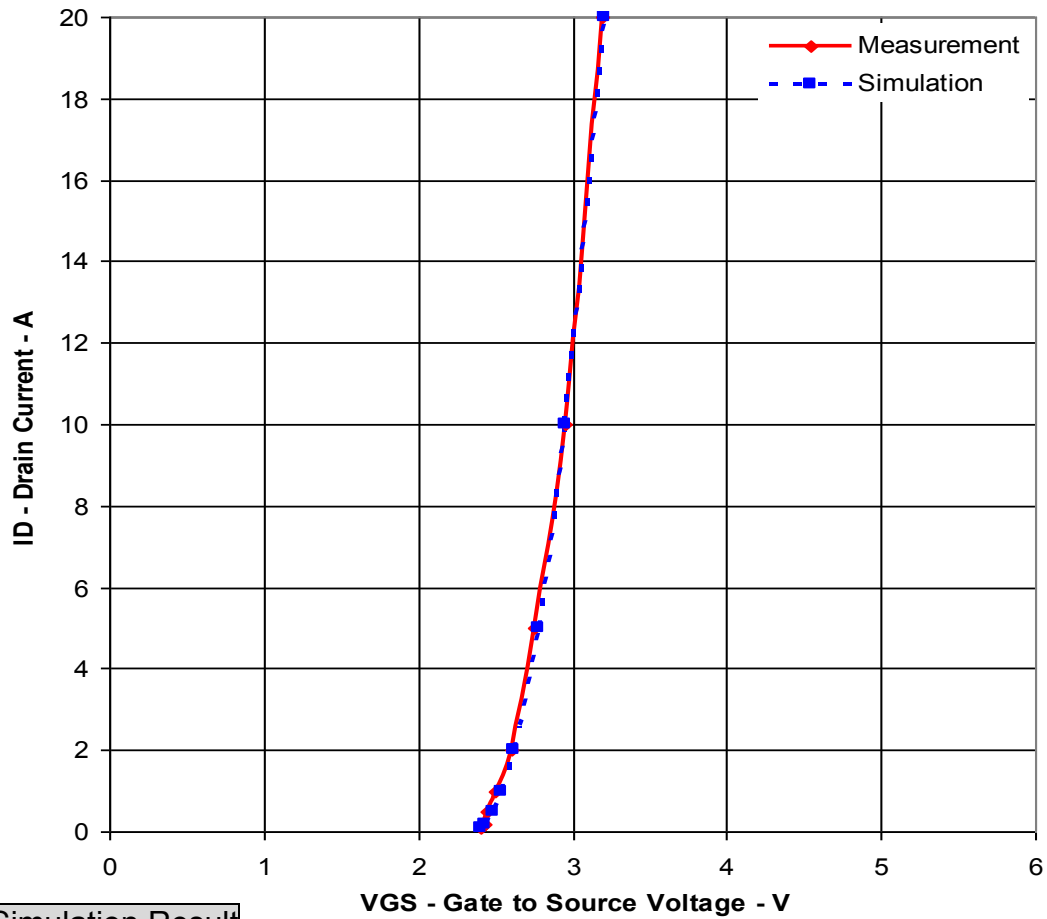


Evaluation circuit



Comparison Graph

Circuit Simulation Result

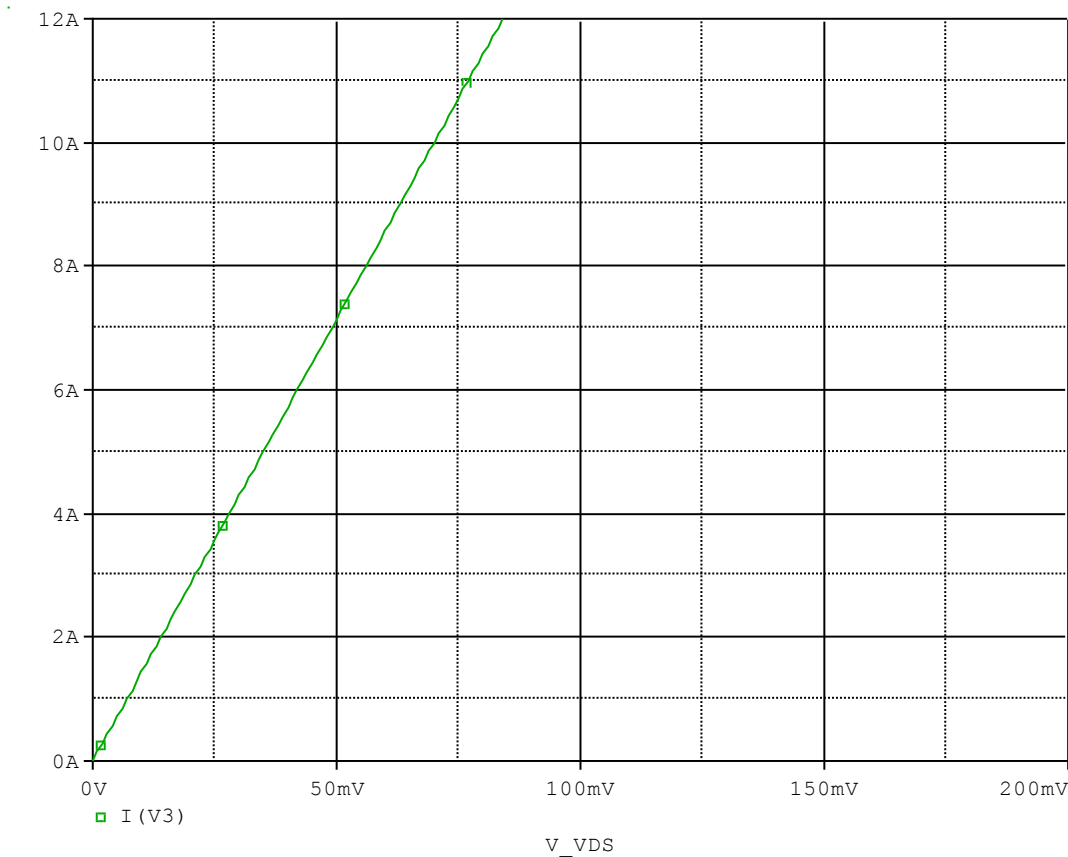


Simulation Result

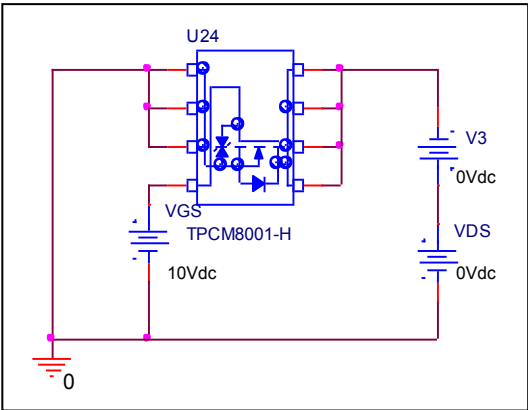
I _D (A)	V _{GS} (V)		Error (%)
	Measurement	Simulation	
0.1	2.400	2.406	0.250
0.2	2.430	2.430	0.000
0.5	2.450	2.480	1.224
1	2.500	2.535	1.400
2	2.600	2.615	0.577
5	2.750	2.773	0.836
10	2.950	2.953	0.102
20	3.200	3.211	0.344

Rds(on) Characteristic

Circuit Simulation result



Evaluation circuit

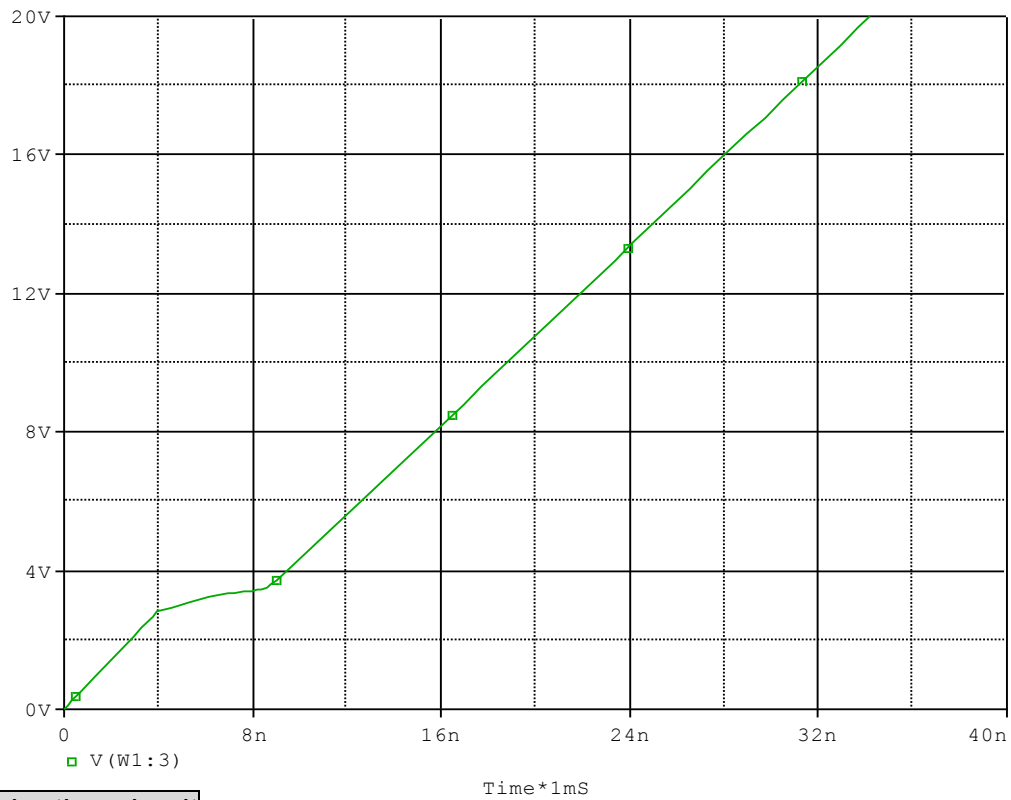


Simulation Result

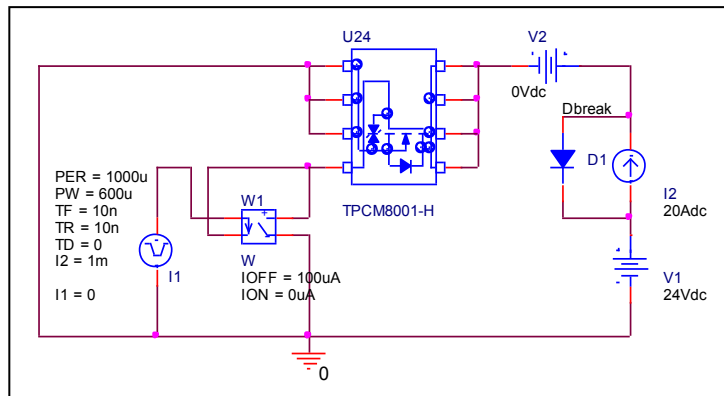
$I_D=14A, V_{GS}=10V$	Measurement		Simulation		Error (%)
$R_{DS} (on)$	7.000	mΩ	7.000	mΩ	0

Gate Charge Characteristic

Circuit Simulation result



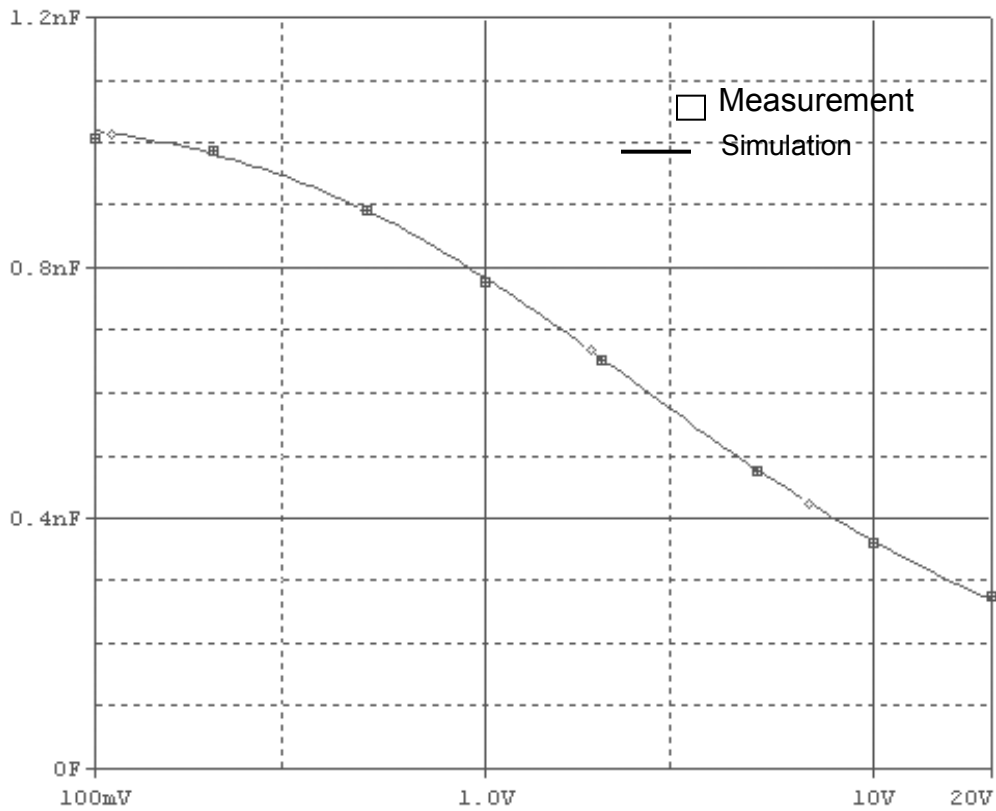
Evaluation circuit



Simulation Result

$V_{DD}=24V, I_D=20A$ $V_{GS}=10V$	Measurement	Simulation	Error (%)
$Q_{gs}(nC)$	3.900	3.929	0.744
$Q_{gd}(nC)$	4.000	4.140	3.500
Q_g	19.000	18.807	-1.016

Capacitance Characteristic

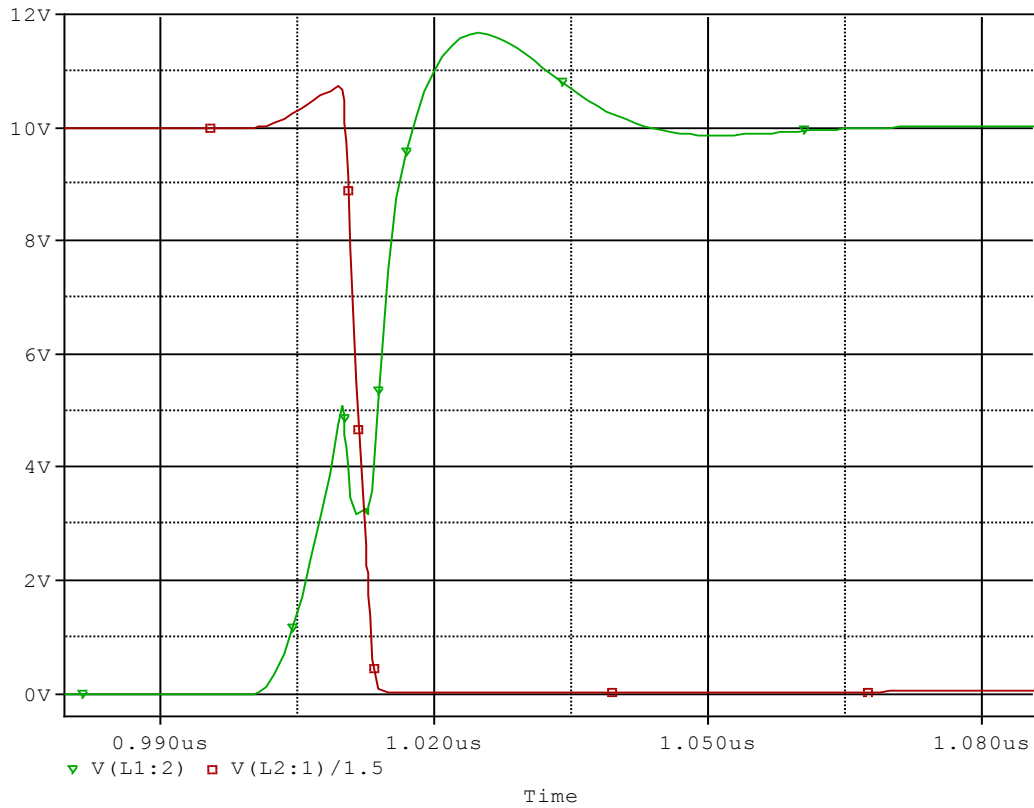


Simulation Result

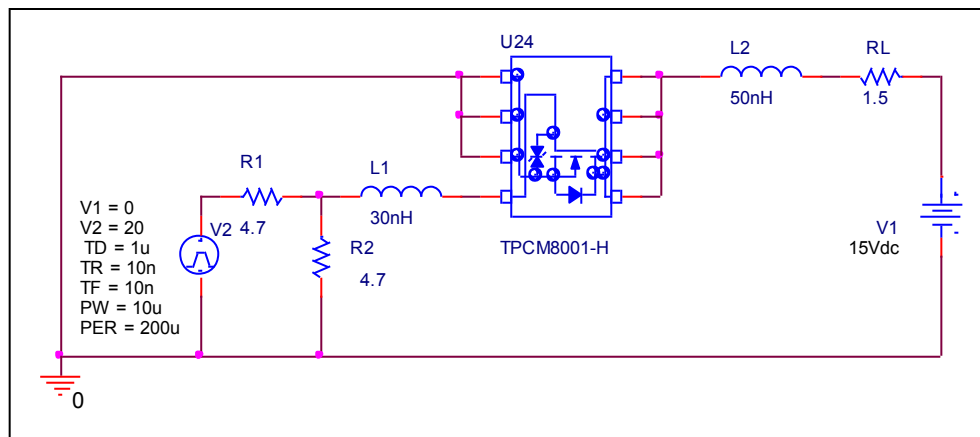
V _{DS} (V)	Cbd(pF)		Error(%)
	Measurement	Simulation	
0.1	1010.000	1017.000	0.693
0.2	990.000	987.000	-0.303
0.5	895.000	895.000	0.000
1	780.000	781.000	0.128
2	655.000	655.000	0.000
5	480.000	480.000	0.000
10	365.000	366.000	0.274
20	280.000	279.000	-0.357

Switching Time Characteristic

Circuit Simulation result



Evaluation circuit

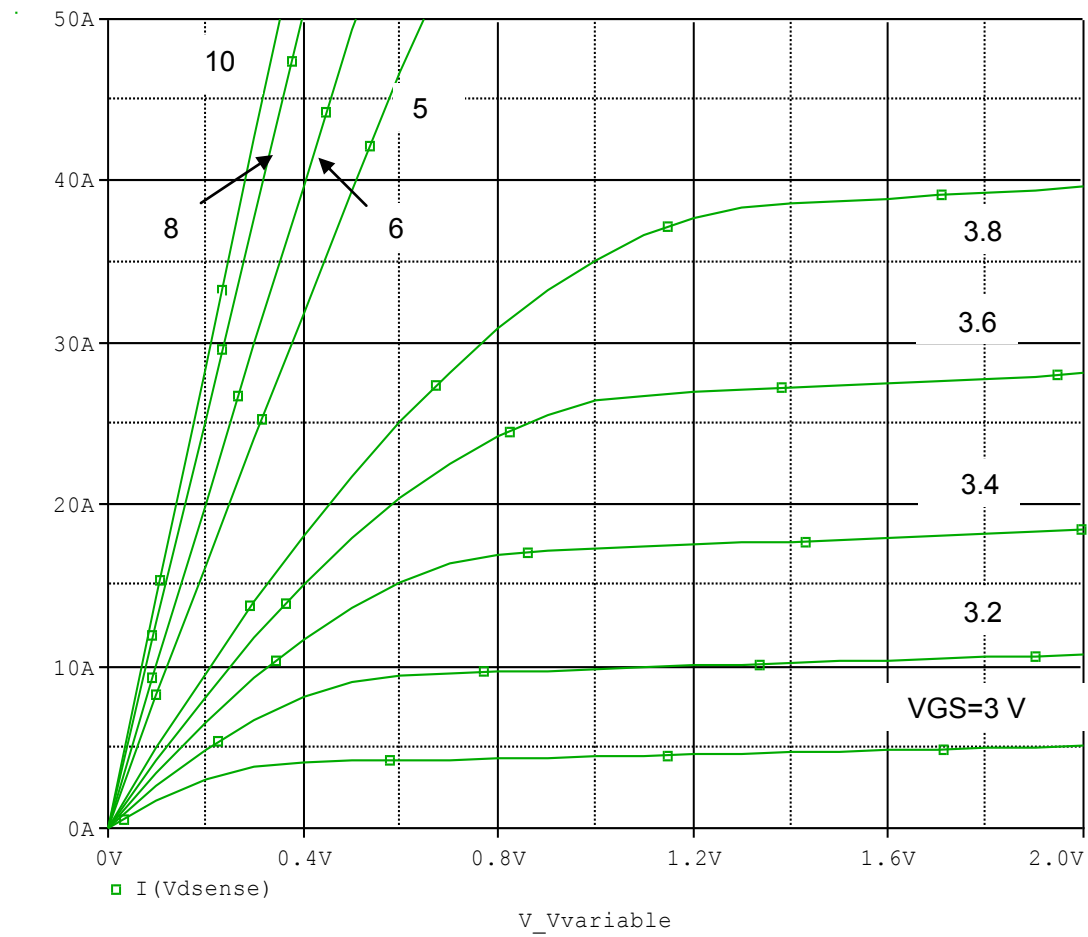


Simulation Result

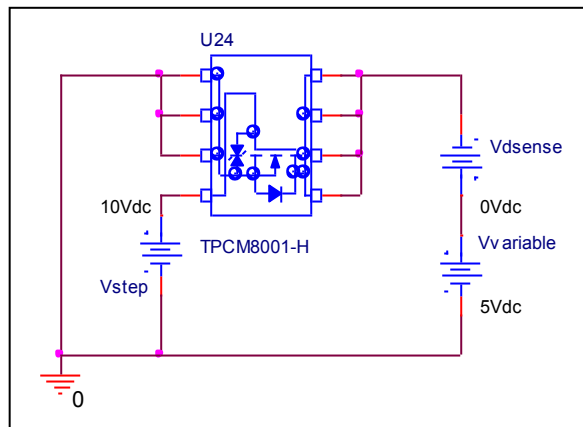
$I_D=14\text{ A}$, $V_{DD}=15\text{ V}$ $V_{GS}=0/10\text{ V}$	Measurement	Simulation	Error(%)
Ton(ns)	9.000	8.991	-0.100

Output Characteristic

Circuit Simulation result

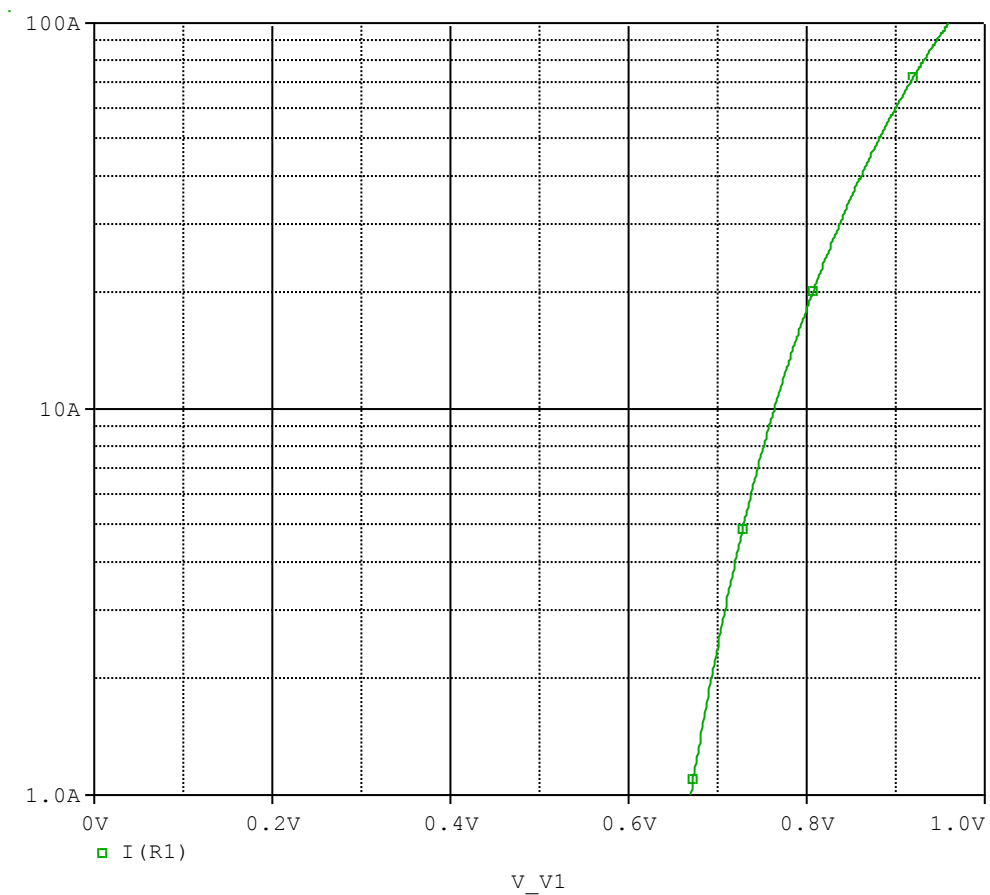


Evaluation circuit

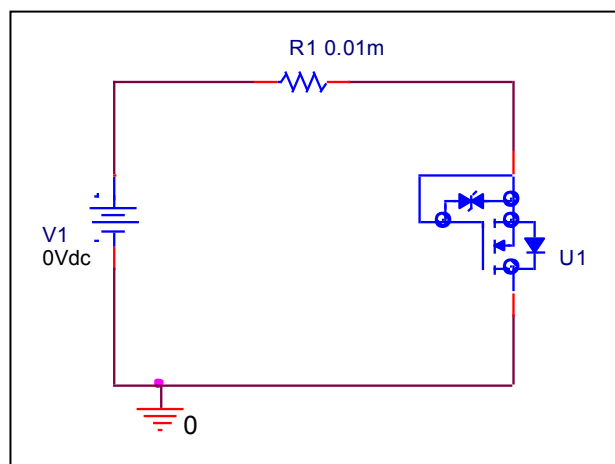


Forward Current Characteristic

Circuit Simulation Result

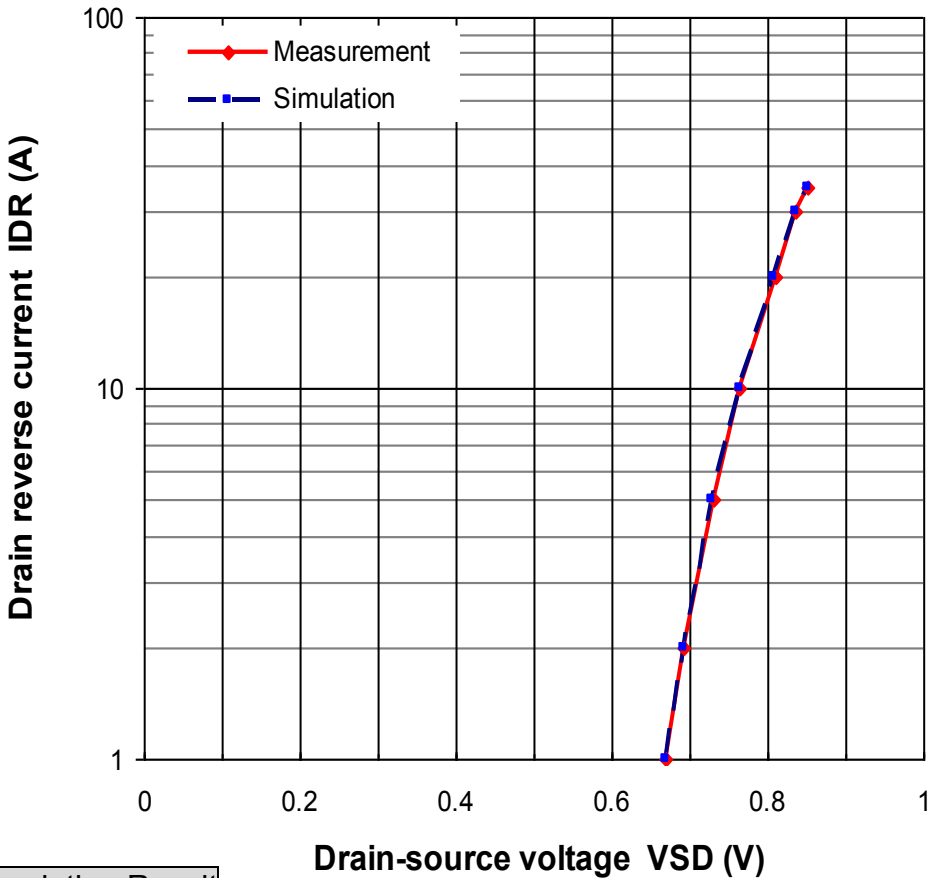


Evaluation Circuit



Comparison Graph

Circuit Simulation Result

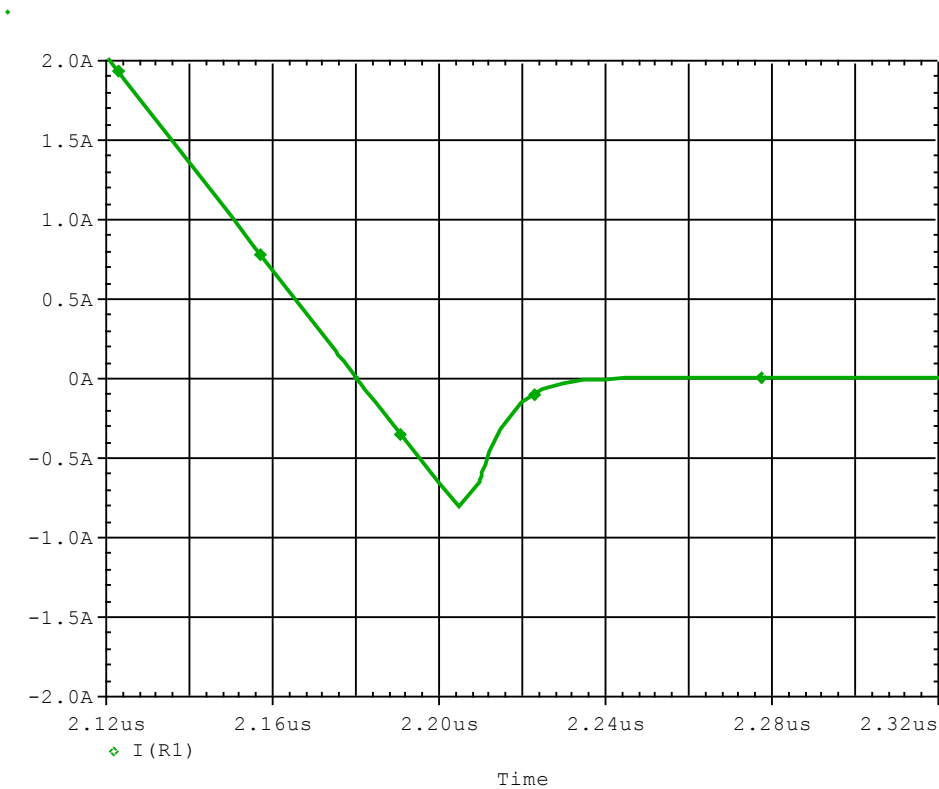


Simulation Result

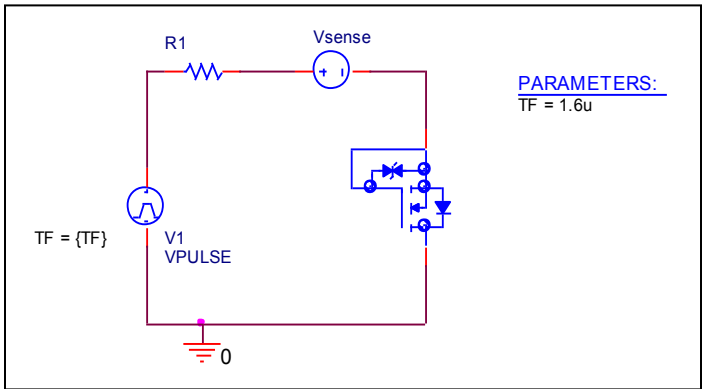
IDR(A)	VSD(V)		%Error
	Measurement	Simulation	
1	0.6700	0.6690	-0.15
2	0.6920	0.6930	0.14
5	0.7300	0.7290	-0.14
10	0.7630	0.7630	0.00
20	0.8100	0.8070	-0.37

Reverse Recovery Characteristics (Body Diode)

Circuit Simulation Result



Evaluation Circuit

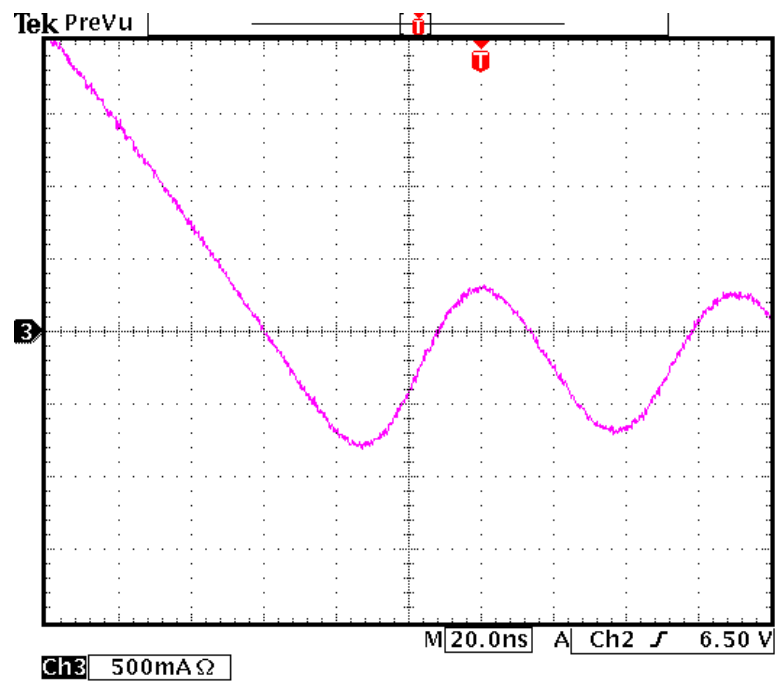


Compare Measurement vs. Simulation

	Measurement		Simulation		Error (%)
ttr	42.8	ns	42.58	ns	-0.51

Reverse Recovery Characteristic (Body Diode)

Reference

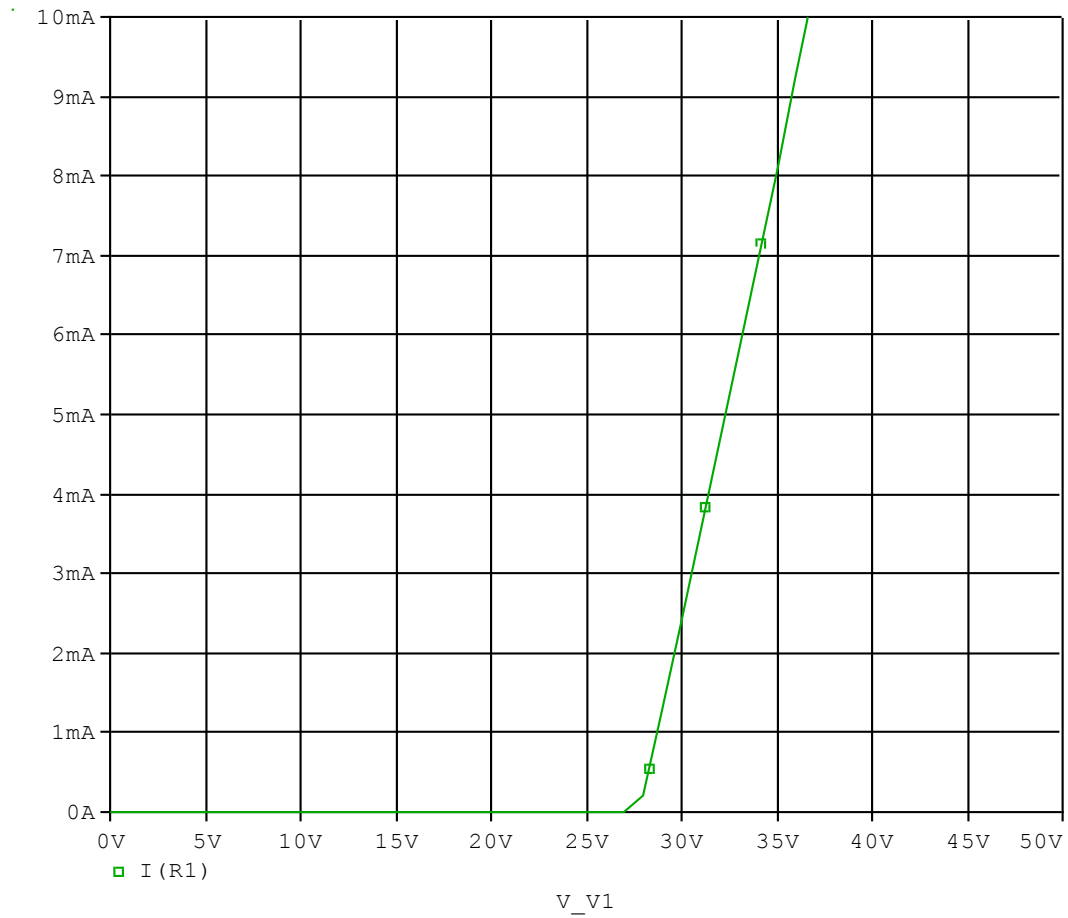


$T_{rr}=42.8\text{ns}$

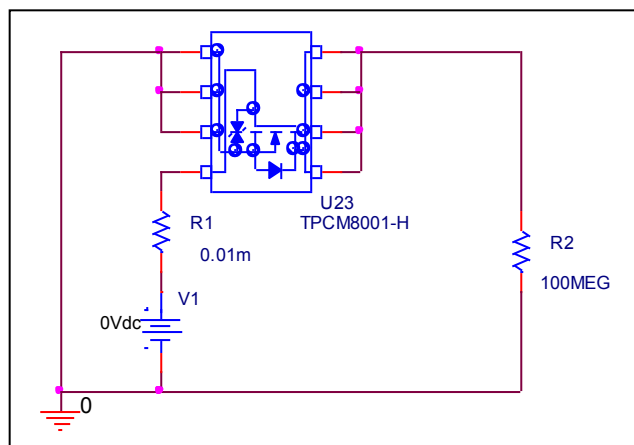
Conditions: $I_{fwd}=di/dt=30\text{A/us}$

Zener Voltage Characteristic

Circuit Simulation Result



Evaluation Circuit



Zener Voltage Characteristic

Reference

